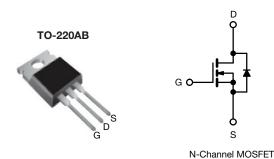
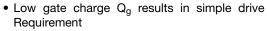


## **Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	500			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	0.28		
Q <sub>g</sub> max. (nC)	130			
Q <sub>gs</sub> (nC)	33			
Q <sub>gd</sub> (nC)	59			
Configuration	Single			

#### **FEATURES**





• Improved gate, avalanche, and dynamic dV/dt ruggedness



- Fully characterized capacitance and avalanche voltage and current
- Low t<sub>rr</sub> and soft diode recovery
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching
- ZVS and high frequency circuit
- · PWM inverters

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFB17N50LPbF

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	e noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	500	V	
Gate-source voltage			$V_{GS}$	± 30		
Continuous drain current	V -+ 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		16	A	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	11		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	64	1	
Linear derating factor				1.8	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	390	mJ	
Repetitive avalanche current a			I <sub>AR</sub>	16	А	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	22	mJ	
Maximum power dissipation	$T_C = 1$	25 °C	$P_{D}$	220	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	13	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting torque				1.1	N · m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Starting  $T_J$  = 25 °C, L = 3.0 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 16 A (see fig. 12)
- c.  $I_{SD} \le 16$  A,  $dI/dt \le 347$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C
- d. 1.6 mm from case



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62		
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.56		

PARAMETER	SYMBOL	TES	ST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub>	500	-	-	V		
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.6	-	V/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V	
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V		_	± 100	nA	
Zava gata valtaga dvain avvvant		V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V		-	-	50	μΑ	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 400  \text{V}$	$V, V_{GS} = 0 V, T_{J} = 125  ^{\circ}C$	-	-	2.0	mA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 9.9 A <sup>b</sup>	-	0.28	0.32	Ω	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	$V_{DS} = 50 \text{ V}, I_D = 9.9 \text{ A}^{\text{ b}}$		-	-	S	
Dynamic								
Input capacitance	$C_{iss}$		-	2760	-			
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	325		-	
Reverse transfer capacitance	C <sub>rss</sub>			-	37		-	
Output consoitance		$V_{GS} = 0 V$	V <sub>DS</sub> = 1.0 V , f = 1.0 MHz	-	3690	-	pF	
Output capacitance	$C_{oss}$	V <sub>GS</sub> = 0 V	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 400 V , f = 1.0 MHz		84	-	1	
Effective output capacitance	C <sub>oss</sub> eff.	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 0 V to 400 V <sup>c</sup>	-	159	-		
Total gate charge	Qg			-	-	130		
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_{D} = 16 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 b		-	33	nC	
Gate-drain charge	$Q_{gd}$	see lig. 0 and 10		-	-	59		
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ = 250 V, $I_{D}$ = 16 A, $R_{g}$ = 7.5 $\Omega$ , see fig. 10 $^{b}$		-	21	-	- ns	
Rise time	t <sub>r</sub>			-	51	-		
Turn-off delay time	t <sub>d(off)</sub>			-	50	-		
Fall time	t <sub>f</sub>			-	28	-		
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.3	-	1.4	Ω	
<b>Drain-Source Body Diode Characteristic</b>	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET sym	bol	-	-	16		
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	showing the integral reverse p - n junction diode		-	-	64	А	
Body diode voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 16 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	170	250	- ns	
		T <sub>J</sub> = 125 °C	$T_J = 25  ^{\circ}\text{C}$ $I_F = 16  \text{A},  \text{dI/dt} = 100  \text{A/}\mu\text{s}^{\text{D}}$		220	330		
Body diode reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C			470	710	nC	
		T <sub>J</sub> = 125 °C			810	1210		
Reverse recovery current	I <sub>RRM</sub>		•	-	7.3	11	Α	
Forward turn-on time	t <sub>on</sub>	Intrinsic tu	ırn-on time is negligible (turn-	on is don	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

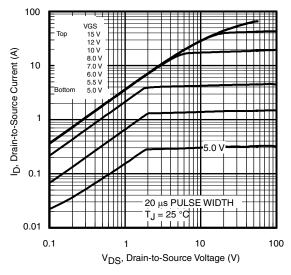


Fig. 1 - Typical Output Characteristics

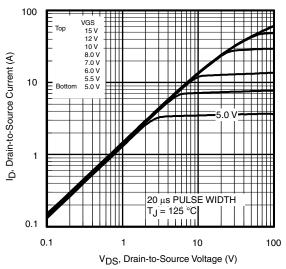


Fig. 2 - Typical Output Characteristics

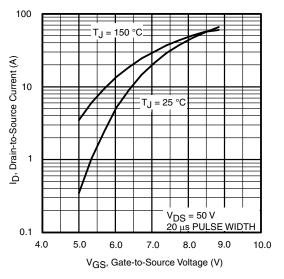


Fig. 3 - Typical Transfer Characteristics

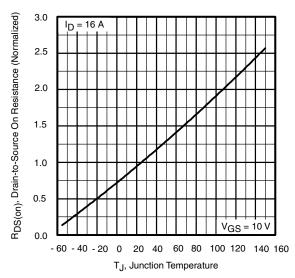


Fig. 4 - Normalized On-Resistance vs. Temperature



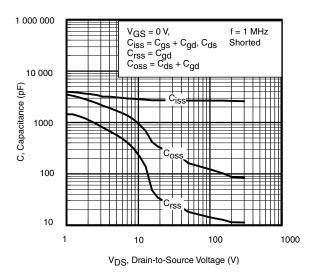


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

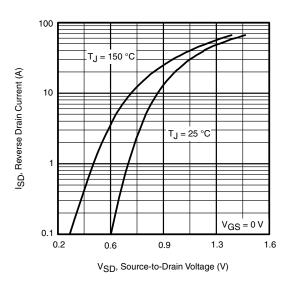


Fig. 7 - Typical Source-Drain Diode Forward Voltage

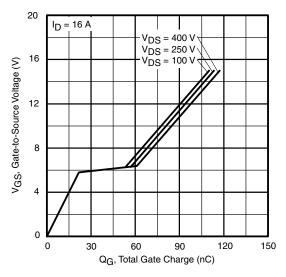


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

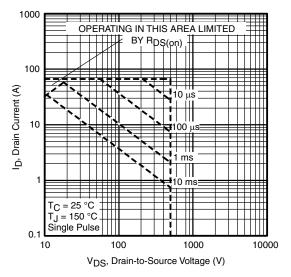


Fig. 8 - Maximum Safe Operating Area



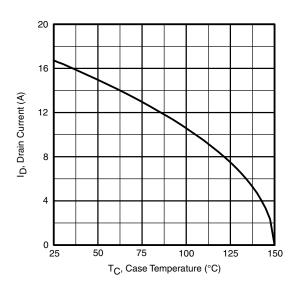


Fig. 9 - Maximum Drain Current vs. Case Temperature

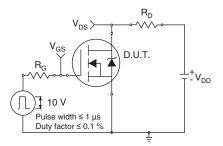


Fig. 10a - Switching Time Test Circuit

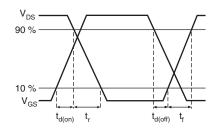


Fig. 10b - Switching Time Waveforms

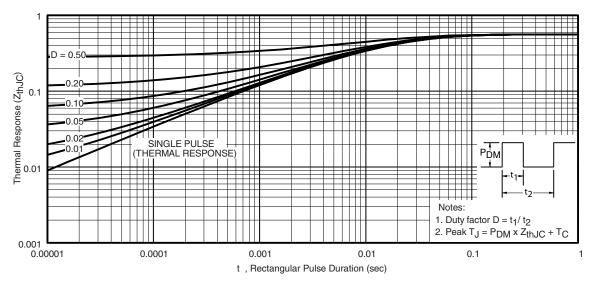


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

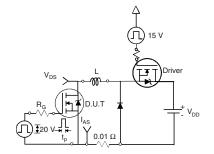


Fig. 12a - Unclamped Inductive Test Circuit

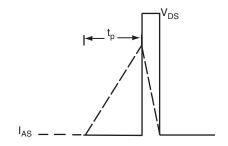


Fig. 12b - Unclamped Inductive Waveforms



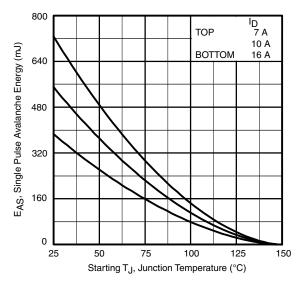


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

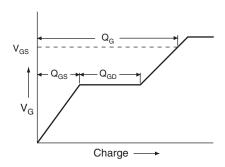


Fig. 13a - Basic Gate Charge Waveform

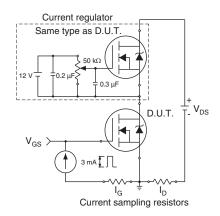
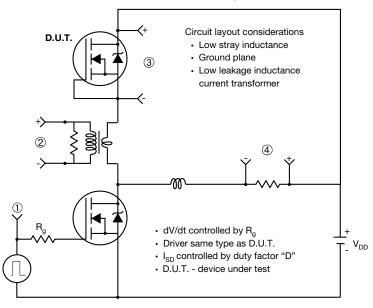


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



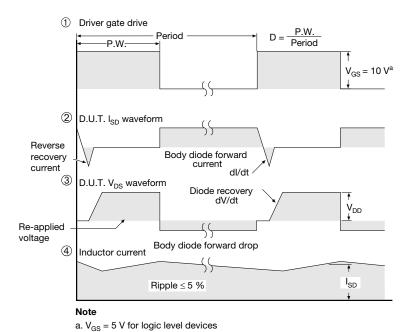


Fig. 14 - For N-Channel

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